

Title (en)

Lithographic apparatus and device manufacturing method

Title (de)

Lithographischer Apparat und Verfahren zur Herstellung einer Vorrichtung

Title (fr)

Appareil lithographique et procédé de fabrication d'un dispositif

Publication

**EP 2339404 A3 20110810 (EN)**

Application

**EP 11162784 A 20060428**

Priority

- EP 06252309 A 20060428
- US 12017605 A 20050503

Abstract (en)

[origin: EP1720074A1] An immersion lithographic apparatus has adaptations (23,27,28,29,30,31,32) to prevent or reduce bubble formation in one or more gaps (22) in the substrate table by preventing bubbles (24) escaping from the gap into the beam path and/or extracting bubbles that may form in the gap.

IPC 8 full level

**G03F 7/20** (2006.01)

CPC (source: EP KR US)

**G03F 7/2041** (2013.01 - KR); **G03F 7/70341** (2013.01 - EP KR US); **G03F 7/7095** (2013.01 - KR)

Citation (search report)

[A] WO 2004053953 A1 20040624 - NIKON CORP [JP], et al & EP 1571695 A1 20050907 - NIKON CORP [JP]

Designated contracting state (EPC)

DE FR GB IT NL

DOCDB simple family (publication)

**EP 1720074 A1 20061108; EP 1720074 B1 20111102**; CN 101794083 A 20100804; CN 101794083 B 20120208; CN 101794084 A 20100804; CN 101794084 B 20130327; CN 1858656 A 20061108; CN 1858656 B 20100512; EP 2267539 A1 20101229; EP 2339403 A2 20110629; EP 2339403 A3 20110824; EP 2339403 B1 20120725; EP 2339404 A2 20110629; EP 2339404 A3 20110810; EP 2339404 B1 20120208; JP 2006313910 A 20061116; JP 2008085370 A 20080410; JP 2010118713 A 20100527; JP 4077849 B2 20080423; JP 4820809 B2 20111124; JP 5235926 B2 20130710; KR 100706922 B1 20070413; KR 20060115612 A 20061109; SG 126920 A1 20061129; TW 200707090 A 20070216; TW 201024916 A 20100701; TW I326004 B 20100611; TW I410745 B 20131001; US 10025196 B2 20180717; US 10353296 B2 20190716; US 10684554 B2 20200616; US 11016394 B2 20210525; US 2006250590 A1 20061109; US 2008259295 A1 20081023; US 2012013871 A1 20120119; US 2012013873 A1 20120119; US 2012127441 A1 20120524; US 2016103399 A1 20160414; US 2017248854 A1 20170831; US 2018321594 A1 20181108; US 2019339623 A1 20191107; US 2020310252 A1 20201001; US 7433016 B2 20081007; US 8115903 B2 20120214; US 9081300 B2 20150714; US 9146478 B2 20150929; US 9229335 B2 20160105; US 9606449 B2 20170328

DOCDB simple family (application)

**EP 06252309 A 20060428**; CN 200610077848 A 20060508; CN 201010150862 A 20060508; CN 201010150870 A 20060508; EP 10180832 A 20060428; EP 11162782 A 20060428; EP 11162784 A 20060428; JP 2006128497 A 20060502; JP 2007324518 A 20071217; JP 2010048947 A 20100305; KR 20060040022 A 20060503; SG 200602939 A 20060502; TW 95114175 A 20060420; TW 99106186 A 20060420; US 12017605 A 20050503; US 201113240946 A 20110922; US 201113242004 A 20110923; US 201213361443 A 20120130; US 201514975513 A 20151218; US 201715470491 A 20170327; US 201816034859 A 20180713; US 201916511809 A 20190715; US 202016901109 A 20200615; US 21342708 A 20080619